

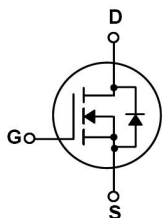
/ Descriptions

/ Features

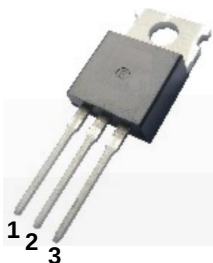
/ Applications

DC/DC

/ Equivalent Circuit



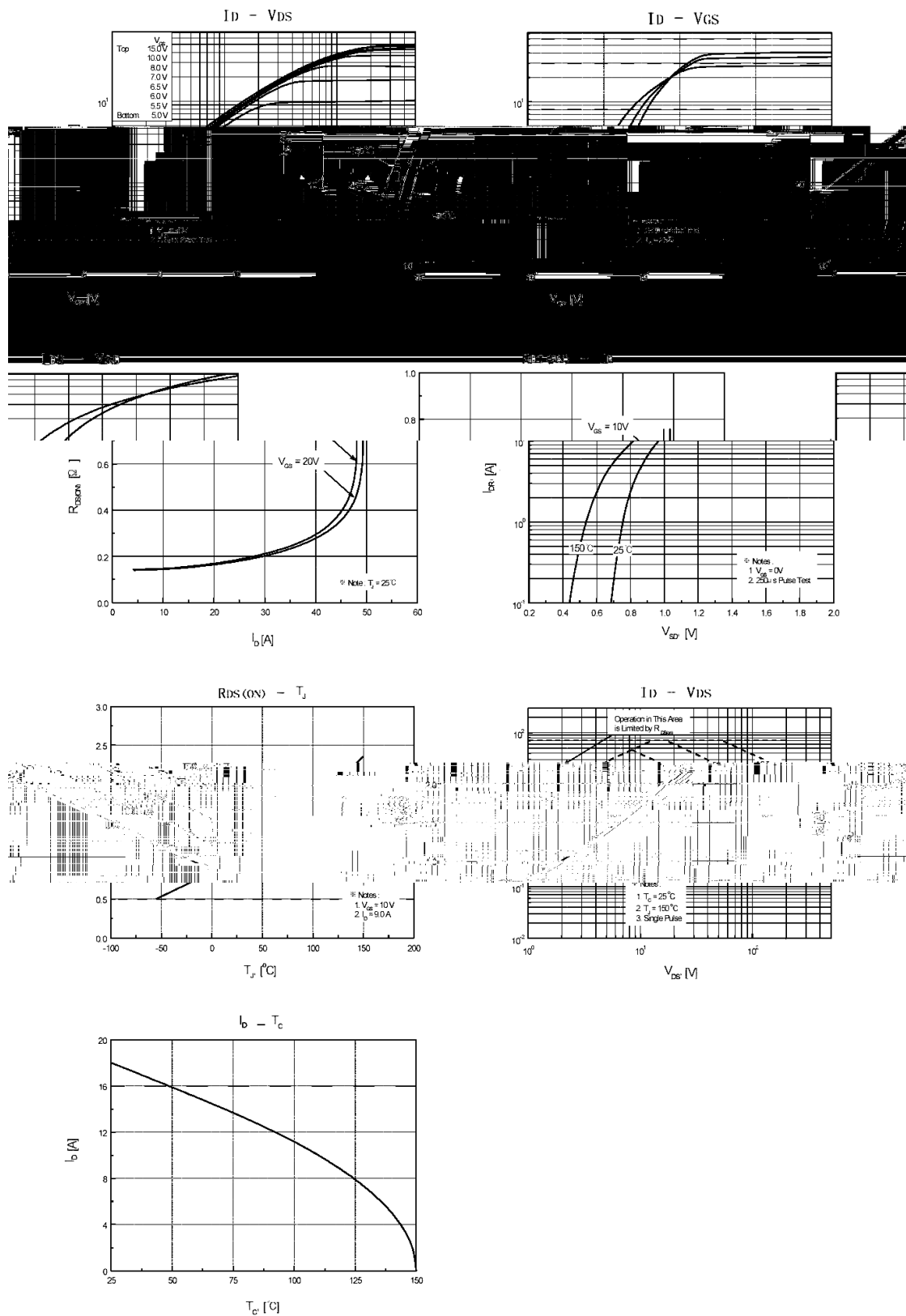
/ Pinning



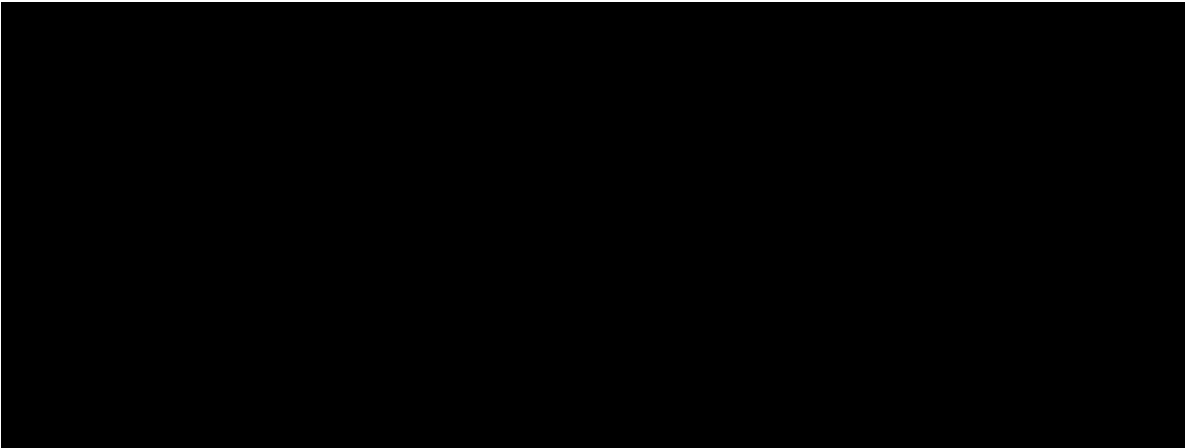
/ h_{FE} Classifications & Marking

		μ				
						μ
						μ
						μ
		μ				

/ Electrical Characteristic Curve



/ Package Dimensions



Dimensions in Millimeters			Dimensions in Millimeters		
Symbol	Min	Max	Symbol	Min	Max
Δ	9.8	10.2	C	0.2	1.4
ϕ	2.56	3.04	ϕ 3	0.57	
9.4		15.74	16.1	B2V	9.02
2.6	b	12.6	13.6	G1	2.2
0.9	b1	9.6	10.6	a1	0.7
0.6	0.4	0.6	0.17	0.05	0.32
2	1.35	1.47	E	2.34	2.74
			a2	1.25	1.45

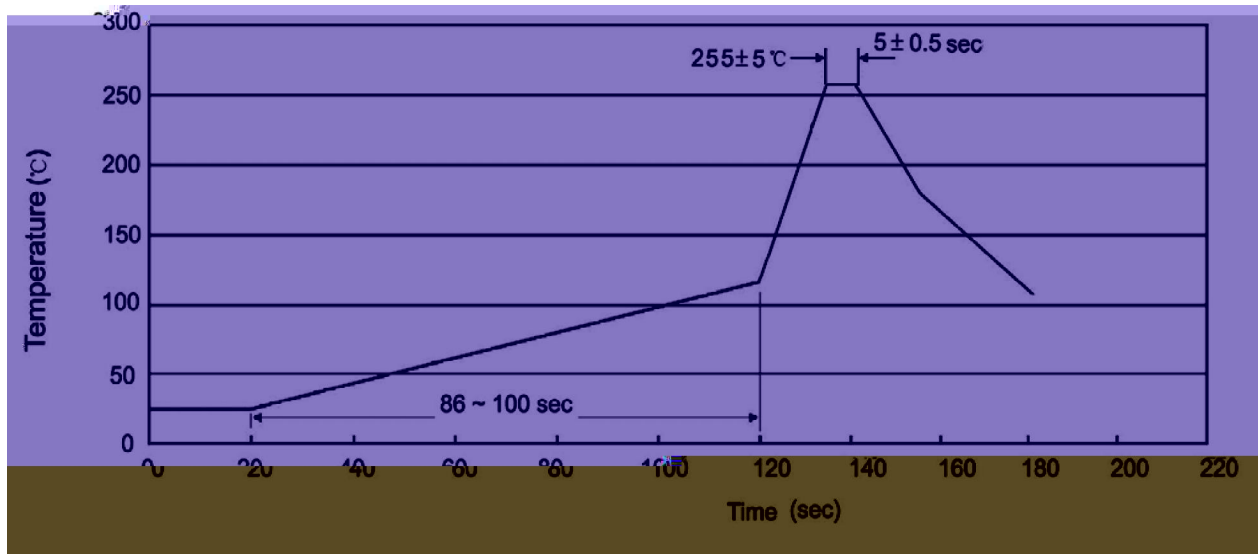
/ Marking Instructions



IRF640

IRF640

() / Temperature Profile for Dip Soldering(Pb-Free)

 $\pm$ $\pm$ $\pm$ $\pm$

/ Resistance to Soldering Heat Test Conditions

 $\pm$ $\pm$

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只袋	袋盒	只盒	盒箱	只箱	袋	盒	箱

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

/ Notices